

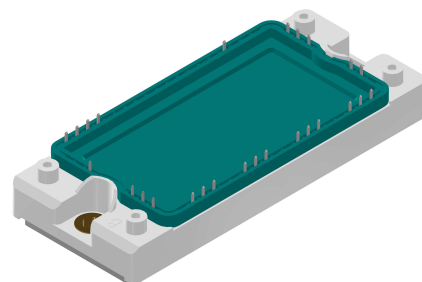
## Standard Rectifier Module

| 3~ Rectifier               | Brake Chopper                 |
|----------------------------|-------------------------------|
| $V_{RRM} = 1600 \text{ V}$ | $V_{CES} = 1200 \text{ V}$    |
| $I_{DAV} = 240 \text{ A}$  | $I_{C25} = 180 \text{ A}$     |
| $I_{FSM} = 1500 \text{ A}$ | $V_{CE(sat)} = 1.7 \text{ V}$ |

### 3~ Rectifier Bridge + Brake Unit

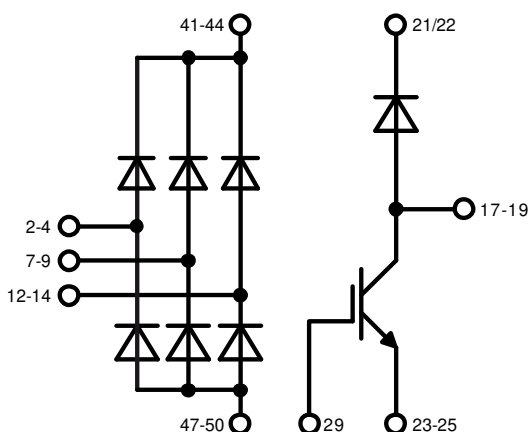
Part number

**MDMA240UB1600ED**



Backside: isolated

 E72873



#### Features / Advantages:

- Package with DCB ceramic
- Improved temperature and power cycling
- Planar passivated chips
- Very low forward voltage drop
- Very low leakage current
- X2PT - 2nd generation Xtreme light Punch Through
- Rugged X2PT design results in:
  - short circuit rated for 10  $\mu\text{sec}$ .
  - very low gate charge
  - low EMI
  - square RBSOA @ 2x  $I_C$
- Thin wafer technology combined with X2PT design results in a competitive low  $V_{CE(sat)}$  and low thermal resistance

#### Applications:

- 3~ Rectifier with brake unit for drive inverters

#### Package: E2-Pack

- Isolation Voltage: 3600 V~
- Industry standard outline
- RoHS compliant
- Soldering pins for PCB mounting
- Height: 17 mm
- Base plate: DCB ceramic
- Reduced weight
- Advanced power cycling

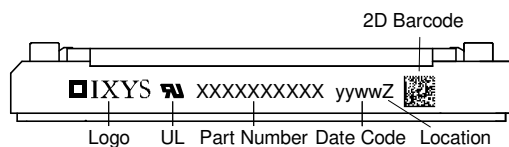
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| Rectifier  |                                              |                                                   |                                                     | Ratings                        |      |      |                   |
|------------|----------------------------------------------|---------------------------------------------------|-----------------------------------------------------|--------------------------------|------|------|-------------------|
| Symbol     | Definition                                   | Conditions                                        |                                                     | min.                           | typ. | max. | Unit              |
| $V_{RSM}$  | max. non-repetitive reverse blocking voltage | $T_{VJ} = 25^{\circ}\text{C}$                     |                                                     |                                |      | 1700 | V                 |
| $V_{RRM}$  | max. repetitive reverse blocking voltage     | $T_{VJ} = 25^{\circ}\text{C}$                     |                                                     |                                |      | 1600 | V                 |
| $I_R$      | reverse current                              | $V_R = 1600\text{ V}$                             | $T_{VJ} = 25^{\circ}\text{C}$                       |                                |      | 100  | $\mu\text{A}$     |
|            |                                              | $V_R = 1600\text{ V}$                             | $T_{VJ} = 150^{\circ}\text{C}$                      |                                |      | 2    | mA                |
| $V_F$      | forward voltage drop                         | $I_F = 80\text{ A}$                               | $T_{VJ} = 25^{\circ}\text{C}$                       |                                |      | 1.28 | V                 |
|            |                                              | $I_F = 240\text{ A}$                              |                                                     |                                |      | 1.92 | V                 |
|            |                                              | $I_F = 80\text{ A}$                               | $T_{VJ} = 125^{\circ}\text{C}$                      |                                |      | 1.22 | V                 |
|            |                                              | $I_F = 240\text{ A}$                              |                                                     |                                |      | 2.02 | V                 |
| $I_{DAV}$  | bridge output current                        | $T_C = 85^{\circ}\text{C}$<br>rectangular         | $T_{VJ} = 150^{\circ}\text{C}$<br>$d = 120^{\circ}$ |                                |      | 240  | A                 |
| $V_{F0}$   | threshold voltage                            | for power loss calculation only                   |                                                     | $T_{VJ} = 150^{\circ}\text{C}$ |      | 0.80 | V                 |
| $r_F$      | slope resistance                             |                                                   |                                                     |                                |      | 5.2  | m $\Omega$        |
| $R_{thJC}$ | thermal resistance junction to case          |                                                   |                                                     |                                |      | 0.4  | K/W               |
| $R_{thCH}$ | thermal resistance case to heatsink          |                                                   |                                                     |                                | 0.1  |      | K/W               |
| $P_{tot}$  | total power dissipation                      | $T_C = 25^{\circ}\text{C}$                        |                                                     |                                |      | 312  | W                 |
| $I_{FSM}$  | max. forward surge current                   | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 45^{\circ}\text{C}$                       |                                |      | 1.50 | kA                |
|            |                                              | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | $V_R = 0\text{ V}$                                  |                                |      | 1.62 | kA                |
|            |                                              | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 150^{\circ}\text{C}$                      |                                |      | 1.28 | kA                |
|            |                                              | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | $V_R = 0\text{ V}$                                  |                                |      | 1.38 | kA                |
| $I^2t$     | value for fusing                             | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 45^{\circ}\text{C}$                       |                                |      | 11.3 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | $V_R = 0\text{ V}$                                  |                                |      | 10.9 | kA <sup>2</sup> s |
|            |                                              | $t = 10\text{ ms}; (50\text{ Hz}), \text{ sine}$  | $T_{VJ} = 150^{\circ}\text{C}$                      |                                |      | 8.13 | kA <sup>2</sup> s |
|            |                                              | $t = 8,3\text{ ms}; (60\text{ Hz}), \text{ sine}$ | $V_R = 0\text{ V}$                                  |                                |      | 7.87 | kA <sup>2</sup> s |
| $C_J$      | junction capacitance                         | $V_R = 400\text{ V}; f = 1\text{ MHz}$            |                                                     |                                | 58   |      | pF                |

| Brake IGBT + Diode |                                      |                                                                                                                  |                                | Ratings |      |          |               |
|--------------------|--------------------------------------|------------------------------------------------------------------------------------------------------------------|--------------------------------|---------|------|----------|---------------|
| Symbol             | Definition                           | Conditions                                                                                                       |                                | min.    | typ. | max.     | Unit          |
| $V_{CES}$          | collector emitter voltage            | $T_{VJ} = 25^{\circ}\text{C}$                                                                                    |                                |         |      | 1200     | V             |
| $V_{GES}$          | max. DC gate voltage                 |                                                                                                                  |                                |         |      | $\pm 20$ | V             |
| $V_{GEM}$          | max. transient gate emitter voltage  |                                                                                                                  |                                |         |      | $\pm 30$ | V             |
| $I_{C25}$          | collector current                    | $T_C = 25^{\circ}\text{C}$                                                                                       |                                |         |      | 180      | A             |
| $I_{C80}$          |                                      | $T_C = 80^{\circ}\text{C}$                                                                                       |                                |         |      | 140      | A             |
| $P_{tot}$          | total power dissipation              | $T_C = 25^{\circ}\text{C}$                                                                                       |                                |         |      | 500      | W             |
| $V_{CE(sat)}$      | collector emitter saturation voltage | $I_C = 100 \text{ A}; V_{GE} = 15 \text{ V}$                                                                     | $T_{VJ} = 25^{\circ}\text{C}$  |         | 1.7  | 2.1      | V             |
|                    |                                      |                                                                                                                  | $T_{VJ} = 125^{\circ}\text{C}$ |         | 1.9  |          | V             |
| $V_{GE(th)}$       | gate emitter threshold voltage       | $I_C = 4 \text{ mA}; V_{GE} = V_{CE}$                                                                            | $T_{VJ} = 25^{\circ}\text{C}$  | 6       | 6.8  | 7.5      | V             |
| $I_{CES}$          | collector emitter leakage current    | $V_{CE} = V_{CES}; V_{GE} = 0 \text{ V}$                                                                         | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.1      | mA            |
|                    |                                      |                                                                                                                  | $T_{VJ} = 125^{\circ}\text{C}$ |         | 0.1  |          | mA            |
| $I_{GES}$          | gate emitter leakage current         | $V_{GE} = \pm 20 \text{ V}$                                                                                      |                                |         |      | 500      | nA            |
| $Q_{G(on)}$        | total gate charge                    | $V_{CE} = 600 \text{ V}; V_{GE} = 15 \text{ V}; I_C = 100 \text{ A}$                                             |                                |         | 340  |          | nC            |
| $t_{d(on)}$        | turn-on delay time                   | inductive load<br>$V_{CE} = 600 \text{ V}; I_C = 100 \text{ A}$<br>$V_{GE} = \pm 15 \text{ V}; R_G = 6.8 \Omega$ | $T_{VJ} = 125^{\circ}\text{C}$ |         | 230  |          | ns            |
| $t_r$              | current rise time                    |                                                                                                                  |                                |         | 70   |          | ns            |
| $t_{d(off)}$       | turn-off delay time                  |                                                                                                                  |                                |         | 380  |          | ns            |
| $t_f$              | current fall time                    |                                                                                                                  |                                |         | 230  |          | ns            |
| $E_{on}$           | turn-on energy per pulse             |                                                                                                                  |                                |         | 12.5 |          | mJ            |
| $E_{off}$          | turn-off energy per pulse            |                                                                                                                  |                                |         | 11.5 |          | mJ            |
| <b>RBSOA</b>       | reverse bias safe operating area     | $V_{GE} = \pm 15 \text{ V}; R_G = 6.8 \Omega$                                                                    | $T_{VJ} = 125^{\circ}\text{C}$ |         |      |          |               |
| $I_{CM}$           |                                      | $V_{CEK} = 1200 \text{ V}$                                                                                       |                                |         |      | 300      | A             |
| <b>SCSOA</b>       | short circuit safe operating area    | $V_{CEK} = 1200 \text{ V}$                                                                                       |                                |         |      |          |               |
| $t_{SC}$           | short circuit duration               | $V_{CE} = 720 \text{ V}; V_{GE} = \pm 15$                                                                        | $T_{VJ} = 125^{\circ}\text{C}$ |         |      | 10       | $\mu\text{s}$ |
| $I_{SC}$           | short circuit current                | $R_G = 6.8 \Omega$ ; non-repetitive                                                                              |                                |         | 450  |          | A             |
| $R_{thJC}$         | thermal resistance junction to case  |                                                                                                                  |                                |         |      | 0.25     | K/W           |
| $R_{thCH}$         | thermal resistance case to heatsink  |                                                                                                                  |                                |         | 0.10 |          | K/W           |
| Brake Diode        |                                      |                                                                                                                  |                                |         |      |          |               |
| $V_{RRM}$          | max. repetitive reverse voltage      |                                                                                                                  | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 1200     | V             |
| $I_{F25}$          | forward current                      |                                                                                                                  | $T_C = 25^{\circ}\text{C}$     |         |      | 88       | A             |
| $I_{F80}$          |                                      |                                                                                                                  | $T_C = 80^{\circ}\text{C}$     |         |      | 59       | A             |
| $V_F$              | forward voltage                      | $I_F = 60 \text{ A}$                                                                                             | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 2.20     | V             |
|                    |                                      |                                                                                                                  | $T_{VJ} = 125^{\circ}\text{C}$ |         | 1.95 |          | V             |
| $I_R$              | reverse current                      | $V_R = V_{RRM}$                                                                                                  | $T_{VJ} = 25^{\circ}\text{C}$  |         |      | 0.1      | mA            |
|                    |                                      |                                                                                                                  | $T_{VJ} = 125^{\circ}\text{C}$ |         |      | 1.2      | mA            |
| $Q_{rr}$           | reverse recovery charge              | $V_R = 600 \text{ V}$<br>$-di_F/dt = 900 \text{ A}/\mu\text{s}$<br>$I_F = 60 \text{ A}; V_{GE} = 0 \text{ V}$    | $T_{VJ} = 125^{\circ}\text{C}$ |         | 9.6  |          | $\mu\text{C}$ |
| $I_{RM}$           | max. reverse recovery current        |                                                                                                                  |                                |         | 47   |          | A             |
| $t_{rr}$           | reverse recovery time                |                                                                                                                  |                                |         | 450  |          | ns            |
| $E_{rec}$          | reverse recovery energy              |                                                                                                                  |                                |         | 3    |          | mJ            |
| $R_{thJC}$         | thermal resistance junction to case  |                                                                                                                  |                                |         |      | 0.6      | K/W           |
| $R_{thCH}$         | thermal resistance case to heatsink  |                                                                                                                  |                                |         | 0.1  |          | K/W           |

| Package E2-Pack      |                                                              |                      |                                         | Ratings |      |      |      |
|----------------------|--------------------------------------------------------------|----------------------|-----------------------------------------|---------|------|------|------|
| Symbol               | Definition                                                   | Conditions           |                                         | min.    | typ. | max. | Unit |
| I <sub>RMS</sub>     | RMS current                                                  | per terminal         |                                         |         |      | 50   | A    |
| T <sub>VJ</sub>      | virtual junction temperature                                 |                      |                                         | -40     |      | 150  | °C   |
| T <sub>op</sub>      | operation temperature                                        |                      |                                         | -40     |      | 125  | °C   |
| T <sub>stg</sub>     | storage temperature                                          |                      |                                         | -40     |      | 125  | °C   |
| Weight               |                                                              |                      |                                         |         | 176  |      | g    |
| M <sub>D</sub>       | mounting torque                                              |                      |                                         | 3       |      | 6    | Nm   |
| d <sub>Spp/App</sub> | creepage distance on surface   striking distance through air | terminal to terminal |                                         | 6.0     |      |      | mm   |
| d <sub>Spt/Apb</sub> |                                                              | terminal to backside |                                         | 12.0    |      |      | mm   |
| V <sub>ISOL</sub>    | isolation voltage                                            | t = 1 second         | 50/60 Hz, RMS; I <sub>ISOL</sub> ≤ 1 mA | 3600    |      |      | V    |
|                      |                                                              | t = 1 minute         |                                         | 3000    |      |      | V    |



### Part description

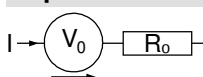
M = Module  
 D = Diode  
 M = Standard Rectifier  
 A = (up to 1800V)  
 240 = Current Rating [A]  
 UB = 3~ Rectifier Bridge + Brake Unit  
 1600 = Reverse Voltage [V]  
 ED = E2-Pack

| Ordering | Ordering Number | Marking on Product | Delivery Mode | Quantity | Code No. |
|----------|-----------------|--------------------|---------------|----------|----------|
| Standard | MDMA240UB1600ED | MDMA240UB1600ED    | Box           | 6        | 520461   |

### Equivalent Circuits for Simulation

\* on die level

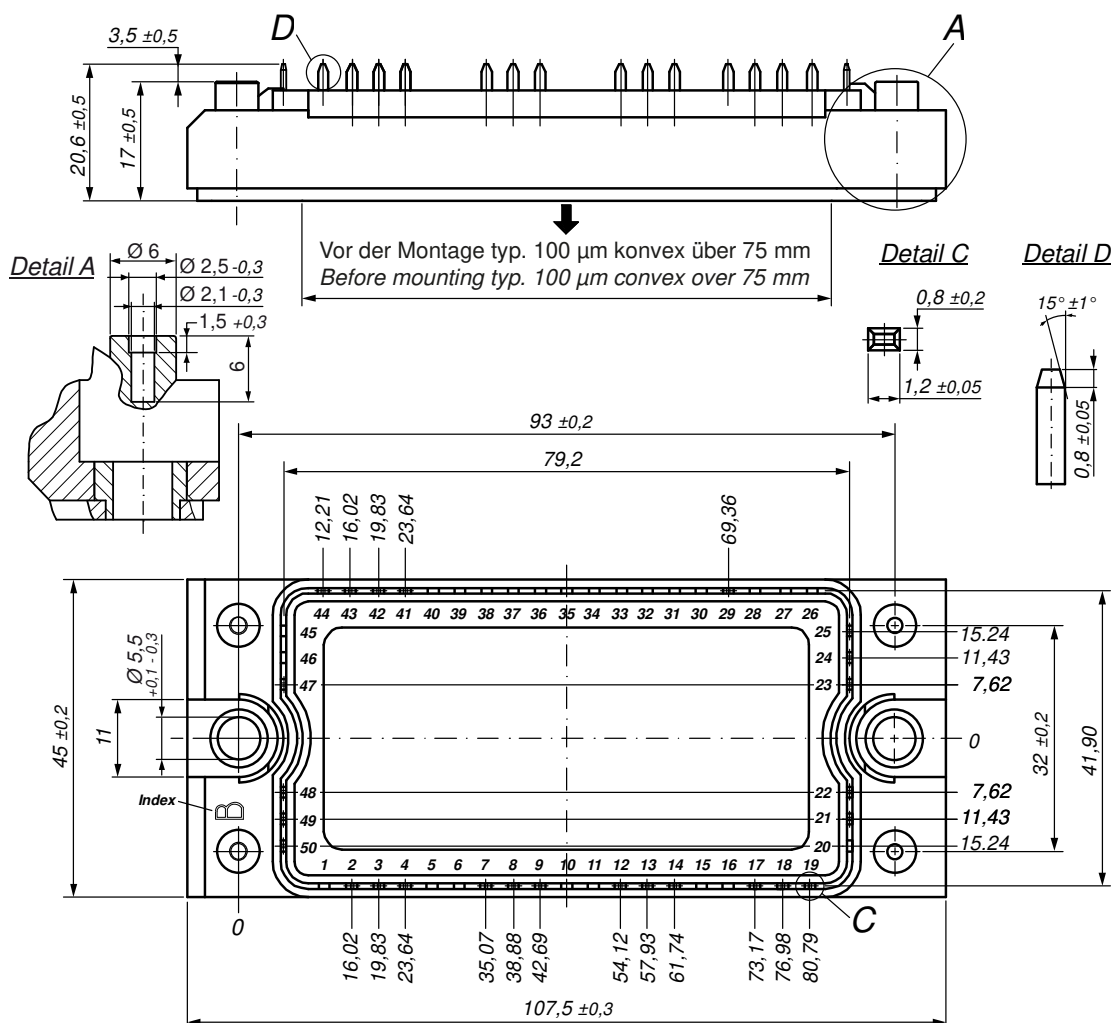
$T_{VJ} = 150^{\circ}\text{C}$



Rectifier

|             |                    |     |    |
|-------------|--------------------|-----|----|
| $V_{0\max}$ | threshold voltage  | 0.8 | V  |
| $R_{0\max}$ | slope resistance * | 2.1 | mΩ |

## Outlines E2-Pack

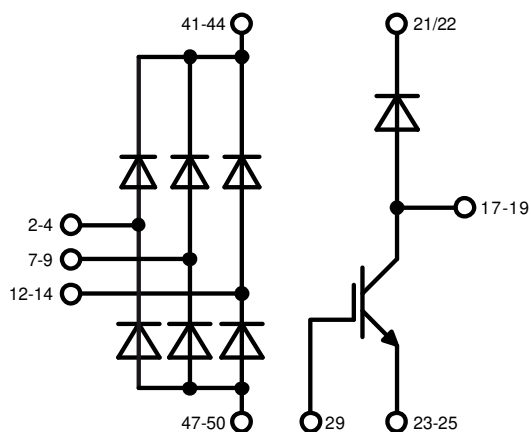


**Bemerkung / Note:**

- Nichttolerierte Maße nach / *Measure without tolerances according DIN ISO 2768-T1-m*  
 - PCB-Lochmuster / *PCB hole pattern: see pin position*  
 - Toleranz Pin-Position und PCB-Lochmuster / *Tolerance of pin position and PCB hole pattern:*  **0.1**  
 - Montageanleitung / *Mounting instruction:* [www.ixys.com](http://www.ixys.com) **Application note IXAN0024**

**Detail A:** PCB-Montage / Mounting on PCB <sup>L</sup>

- Empfohlene, selbstschneidende Schraube / *Recommended, self-tapping screw*: **EJOT PT®** (Größe / *size*: **K25**)<sup>L</sup>  
 - Max. Schraubenlänge / *Max. screw length*: **PCB-Dicke / thickness + 6 mm** (max. Lochtiefe / *hole depth*)<sup>L</sup>  
 - Empfohlenes Drehmoment / *Recommended mounting torque*: **1.5 Nm**



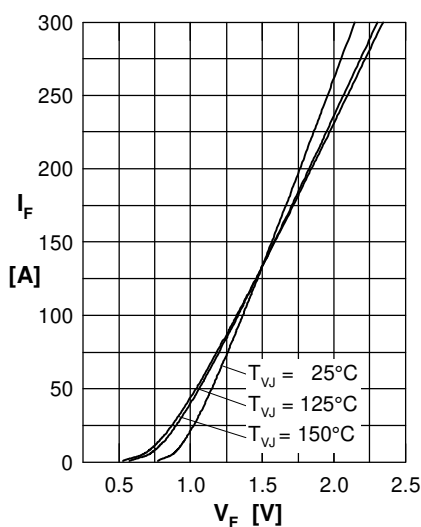
**Rectifier**


Fig. 1 Forward current versus voltage drop per diode

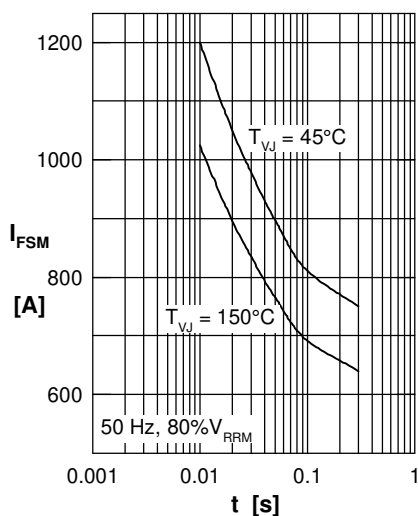


Fig. 2 Surge overload current vs. time per diode

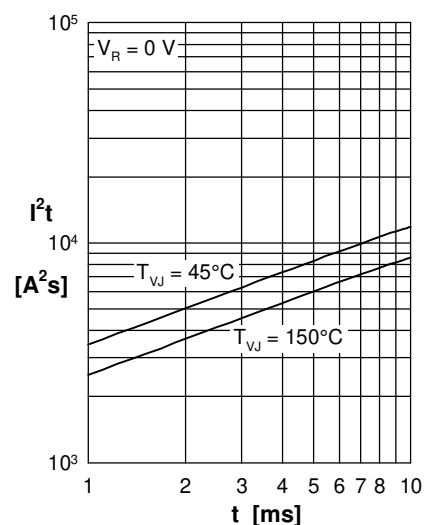
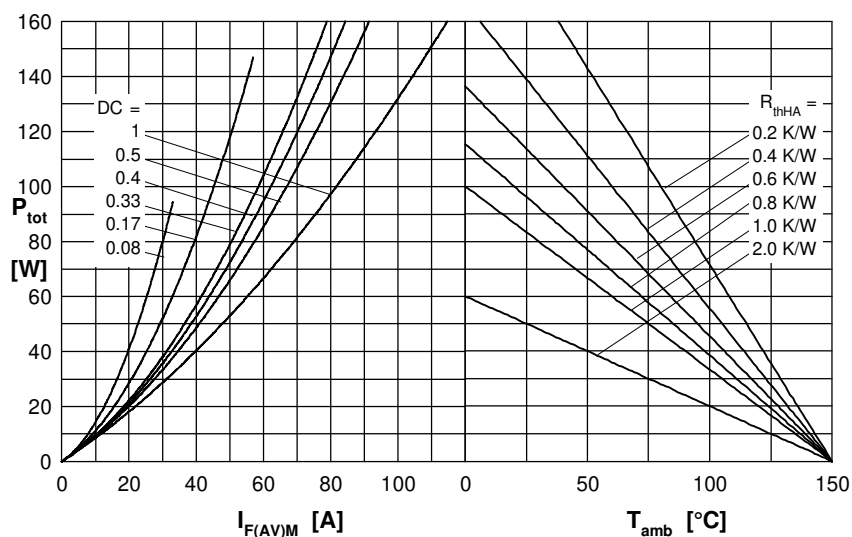

 Fig. 3  $I^2t$  versus time per diode


Fig. 4 Power dissipation vs. forward current and ambient temperature per diode

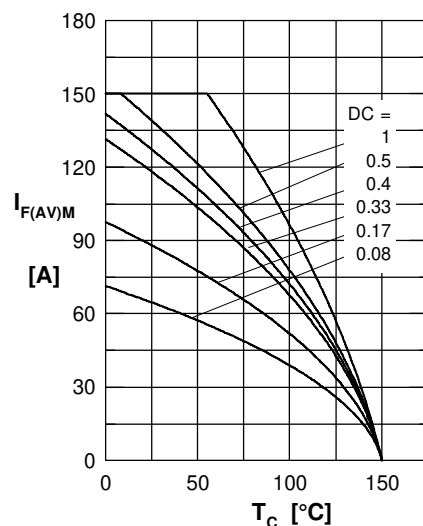


Fig. 5 Max. forward current vs. case temperature per diode

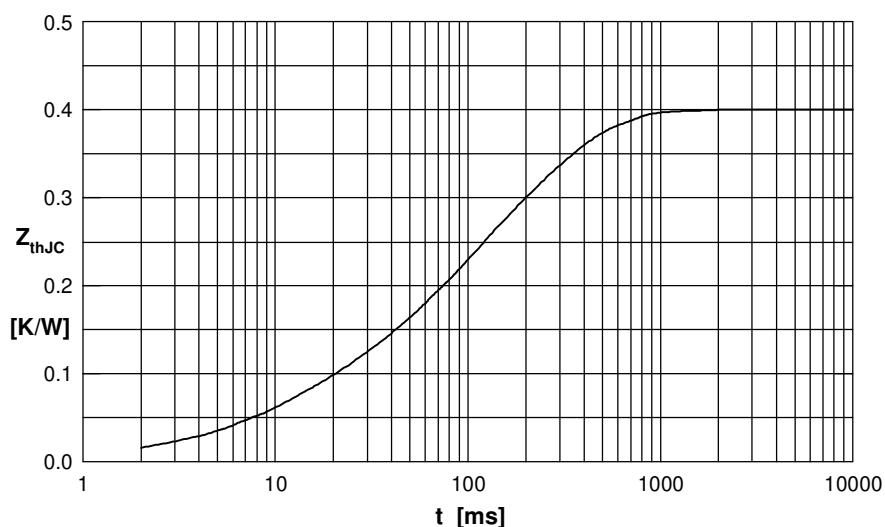


Fig. 6 Transient thermal impedance junction to case vs. time per diode

 Constants for  $Z_{thJC}$  calculation:

| i | $R_{thi}$ (K/W) | $t_i$ (s) |
|---|-----------------|-----------|
| 1 | 0.050           | 0.010     |
| 2 | 0.003           | 0.007     |
| 3 | 0.090           | 0.055     |
| 4 | 0.187           | 0.250     |
| 5 | 0.070           | 0.120     |

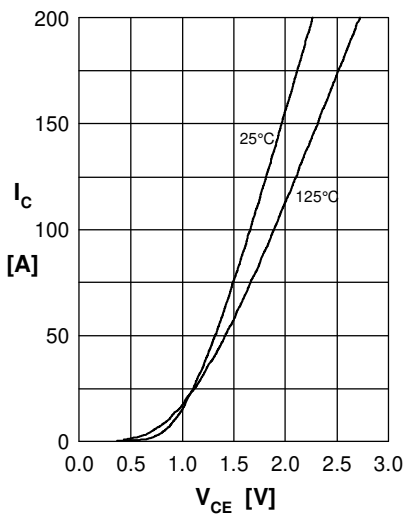
**Brake IGBT + Diode**


Fig.1 Output characteristics IGBT

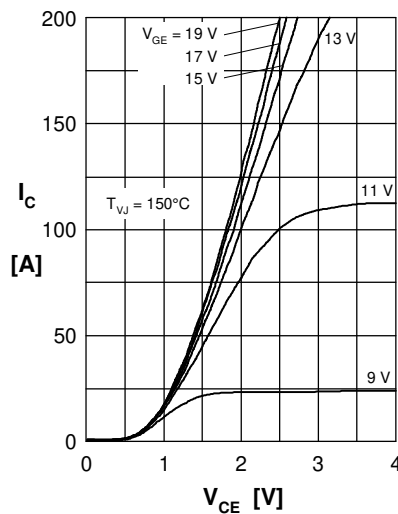


Fig.2 Typ. output characteristics IGBT

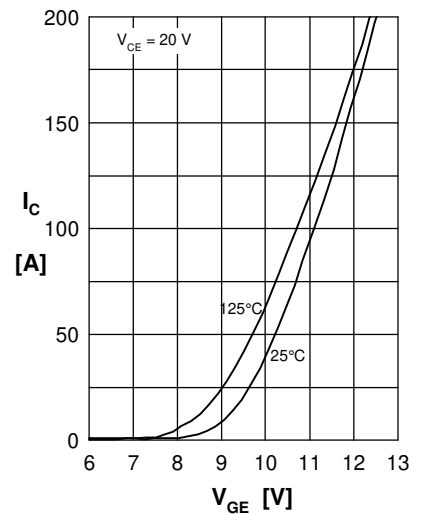


Fig.3 Typ. transfer charact. IGBT

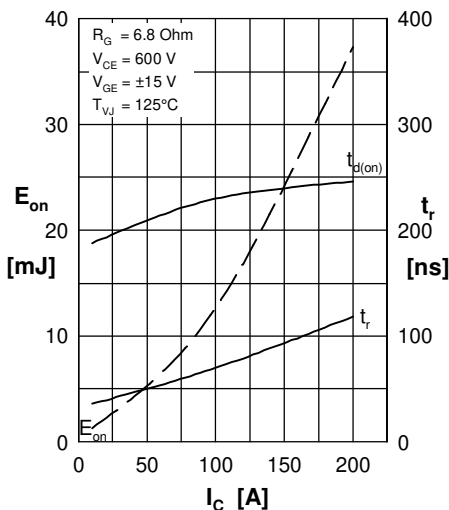


Fig.4 Typ. turn-on energy &amp; switch. times vs. collector current

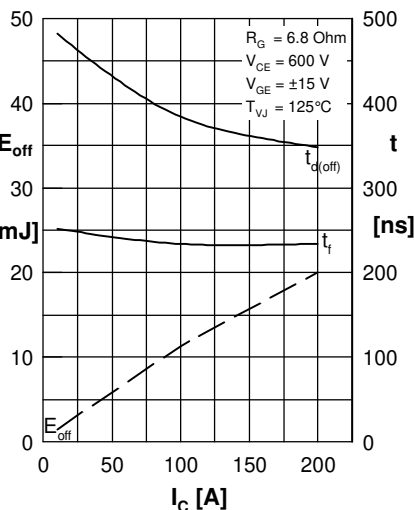


Fig.5 Typ. turn-off energy &amp; switch. times vs. collector current

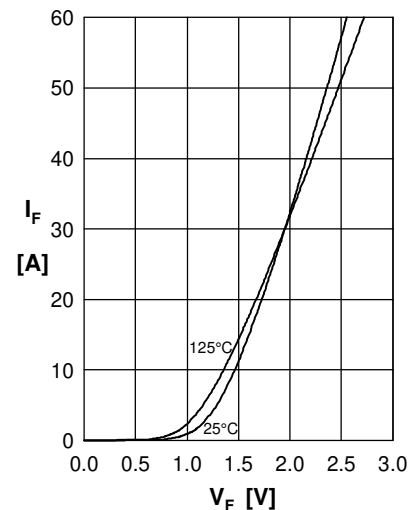
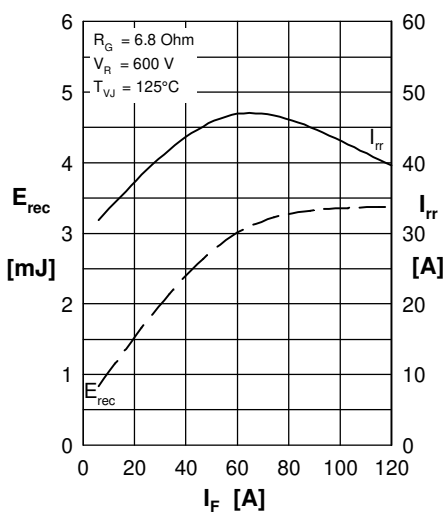

 Fig.6 Typ. forward current versus  $V_F$ 


Fig.7 Typ. reverse recovery characteristics Diode

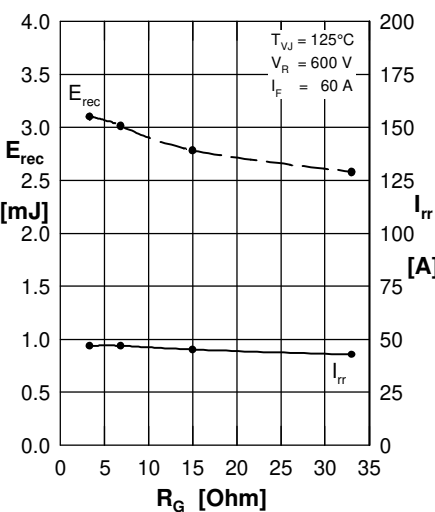


Fig.8 Typ. reverse recovery characteristics Diode

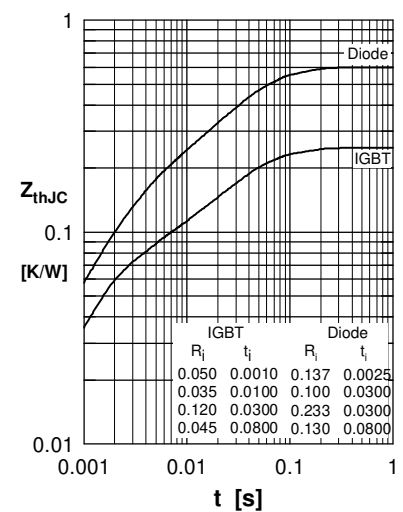


Fig.9 Transient thermal resistance junction to case